









Mira EM Modules

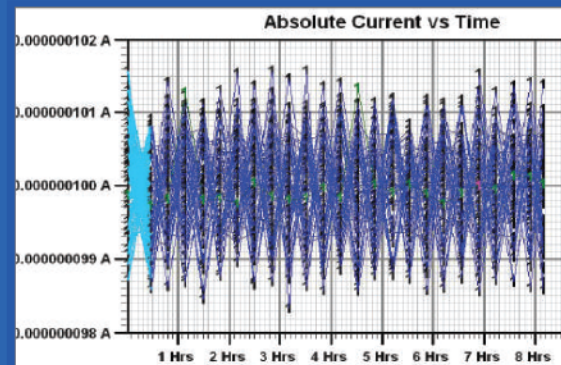
High Performance EM - TSV - Bump Systems



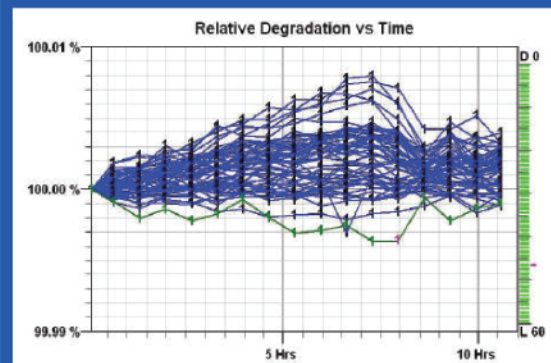
MIRA EM MODULE ADVANTAGES:

-  60 individual current sources per module.
-  The most accurate and precise parallel system on the market.
-  Low nA to 8 amps per source, capable modules.
-  Voltage stress option available.
-  Superior high voltage compliance compared to the competition.
-  Preferred over the competition in all side-by-side on-site customer evaluations.
-  High throughput—supports hundreds of devices per system. Modular architecture.
-  Advanced patented hardware technology.

High Accuracy EM



High Precision EM



Graph shows precision of Module S632-24

Consult QualiTau for detailed specifications.

TESTING THE FUTURE